

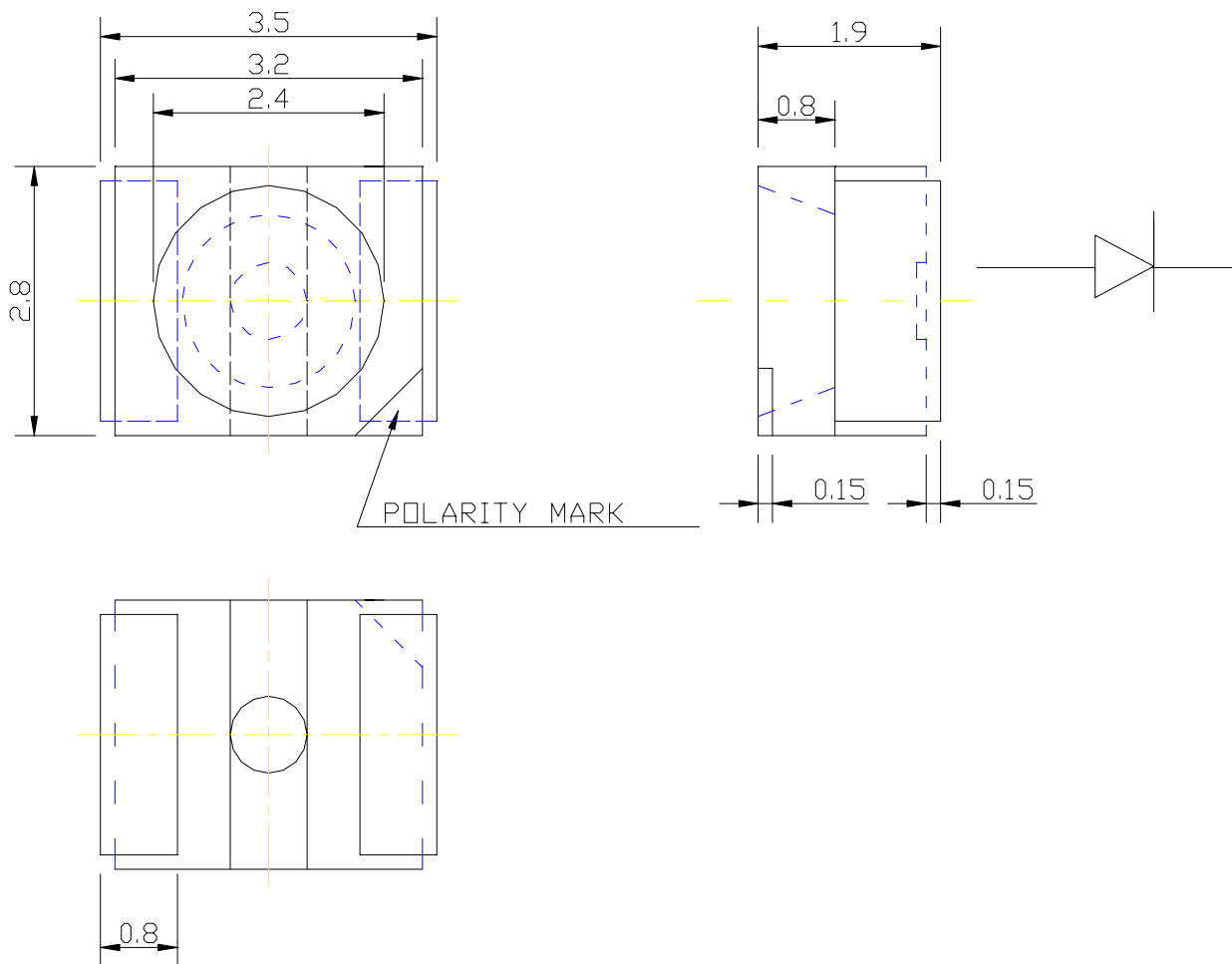
PRODUCT SPECIFICATION

DATE: 08/13/2004

cosmo ELECTRONICS CORPORATION	SMD LED : KL-670UYX	NO. 61L40006	REV. 1
		SHEET 1 OF 9	

UNIT:MM

TOLERANCE: ± 0.25



Part No.	Emitting Color	Material	Lens Type	I _v (I _f =20mA)		Viewing Angle 2 θ 1/2
				MIN (mcd)	TYP (mcd)	
KL-670UYX	Super brightness yellow	AlGaInP	Water Clear	100	150	120°

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		SHEET 2 OF 9	

Absolute maximum ratings (TA=25°C)		QY Yellow (AlGaInP)	Unit
Reverse voltage	V _R	5	V
Forward current	I _F	30	mA
Forward current(Peak) 1/10 Duty Cycle,0.1ms Pulse Width	I _{FP}	100	mA
Power dissipation	P _d	50	mW
LED LAMPS:			
Operating temperature	T _{OP}	-40~+85	°C
Storage temperature	T _{ST}	-40~+85	°C
LED DISPLAYS:			
Operating temperature	T _A	-40~+85	°C
Storage temperature	T _{STG}	-40~+85	°C

Operating characteristics (TA=25°C)		QY Yellow (AlGaInP)	Unit
Forward voltage(typ.)	V _F	2.0	V
I _F =20mA			
Forward voltage(max.)	V _F	2.6	V
I _F =20mA			
Reverse current(max.)	I _R	10	uA
V _R =5V			
Wavelength at dominant emission(typ.)	λ _D	590	nm
I _F =20mA			
Wavelength at peak emission(typ.)	λ _P	592	nm
I _F =20mA			
Spectral line half-width	Δλ	20	nm
I _F =20mA			
Capacitance	C	33	pF
V _F =0V,f=1MHz			

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SMD LED :

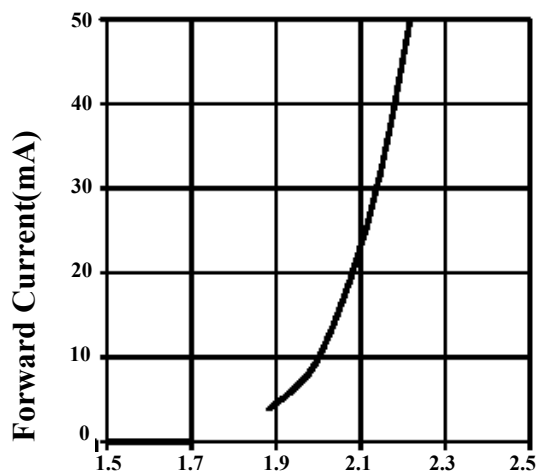
KL-670UYX

NO.61L40006

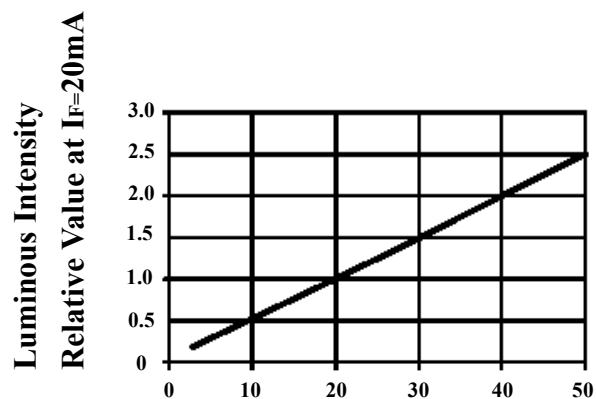
SHEET 3 OF 9

REV.

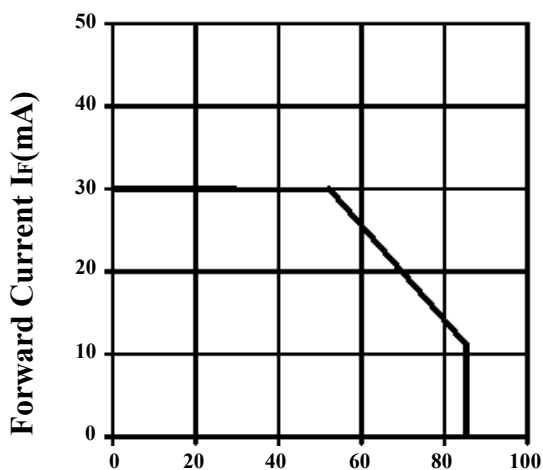
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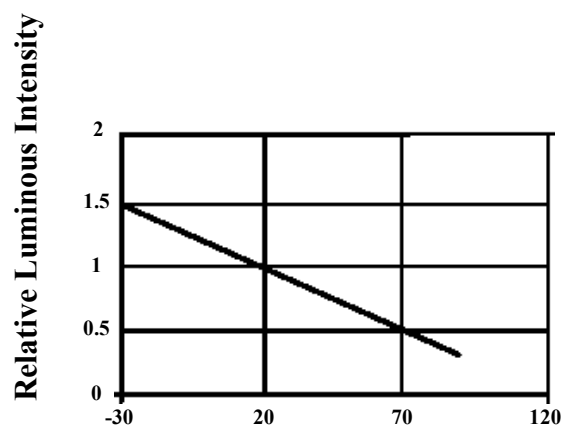
Forward Current Vs.
Forward Voltage



Luminous Intensity Vs.
Forward Current



Forward Current
Derating Curve



Luminous Intensity Vs.
Ambient Temperature

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SMD LED :

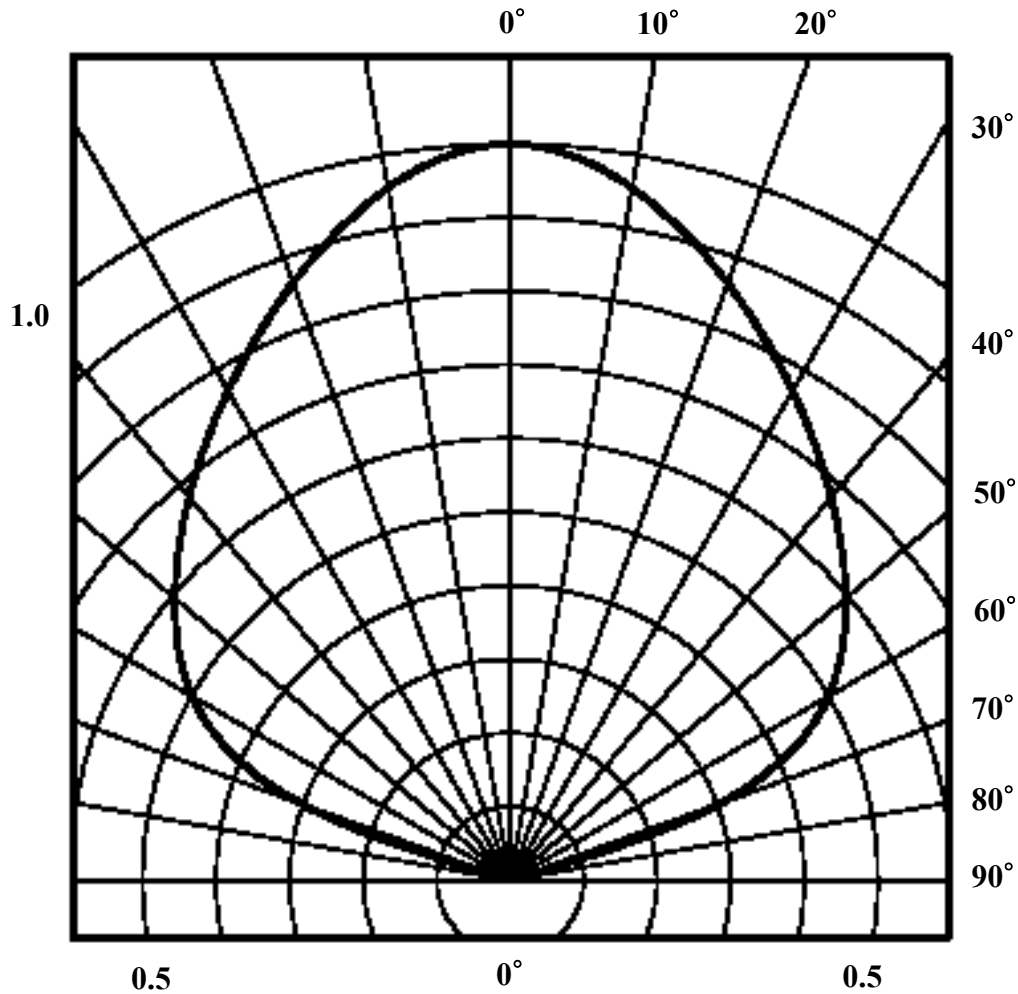
KL-670UYX

NO. 61L40006

SHEET 4 OF 9

REV.

1



View Angle $2\theta_{1/2}=120^\circ$

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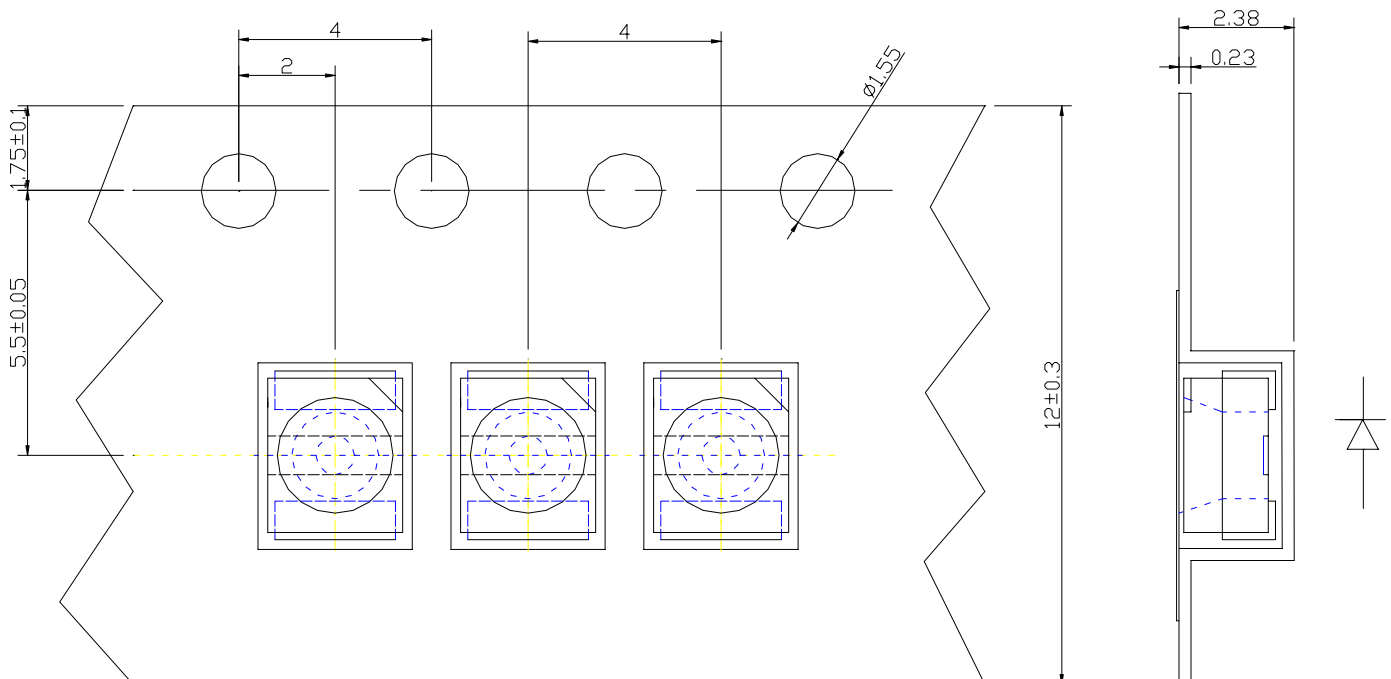
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		SHEET 5 OF 9	

UNIT:MM

TOLERANCE: ± 0.25

TYPE \longrightarrow PACKAGE:1500 OR 1000PCS/REEL
REEL "T":18mmTYP



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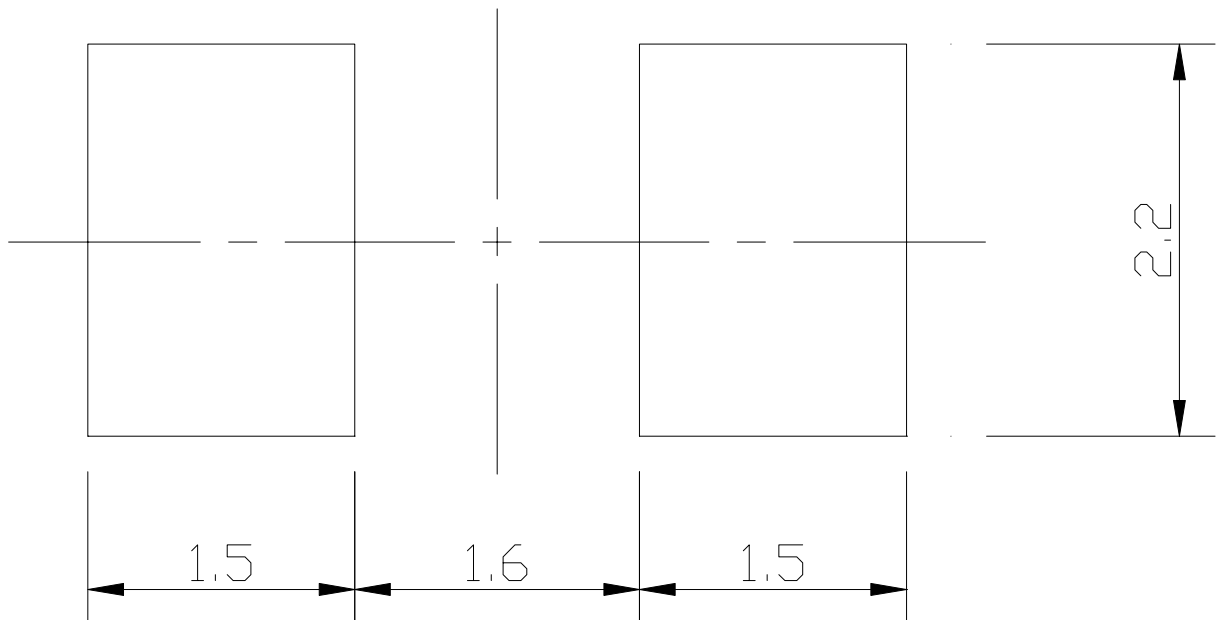
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UNIT:MM

The following soldering patterns are
recommended for reflow-soldering:

For reflow soldering



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NO. 61L40006

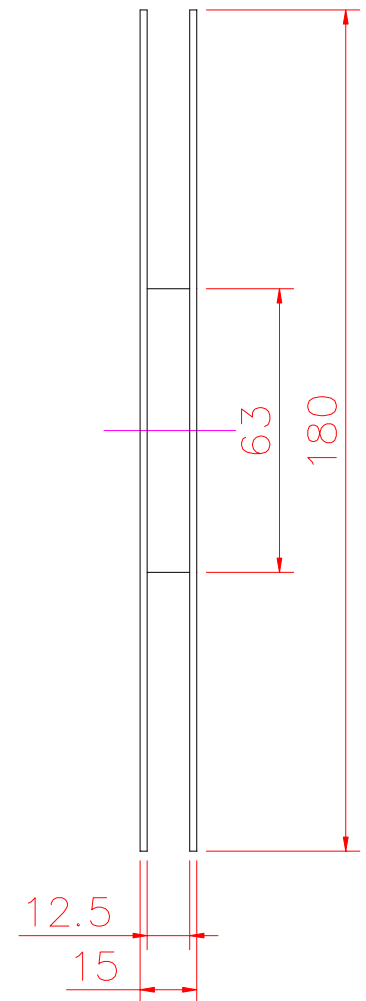
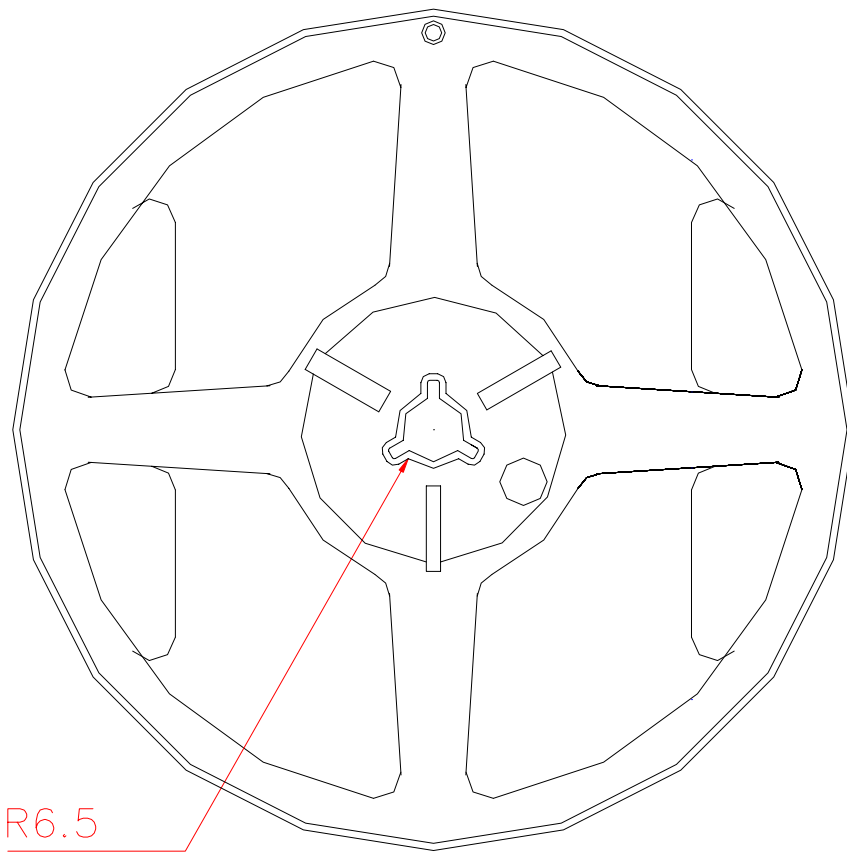
SHEET 7 OF 9

REV.

1

UNIT:MM

TOLERANCE: ± 0.25



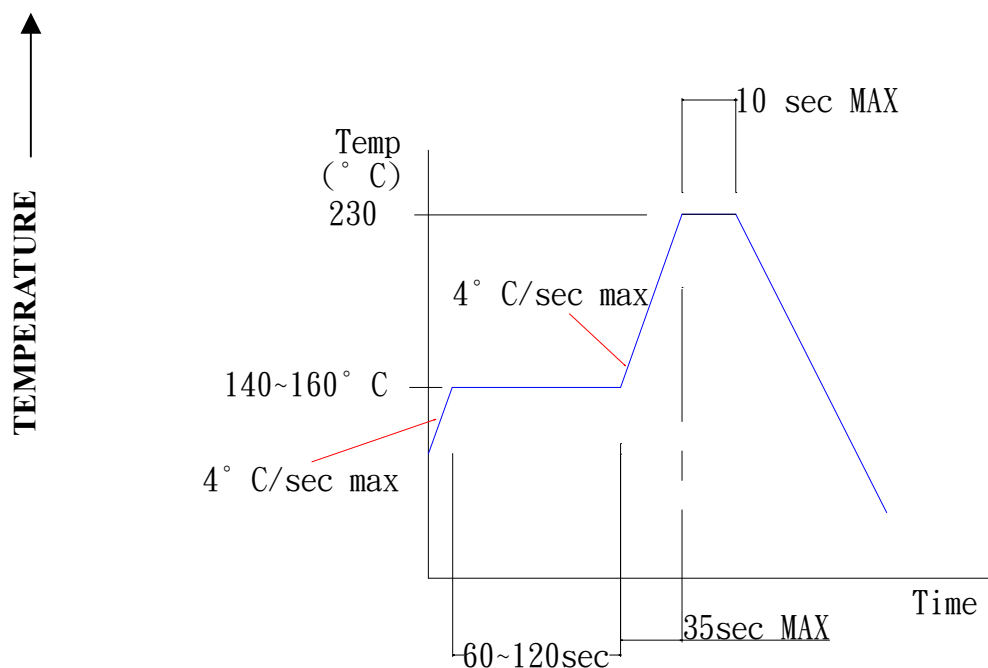
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		SHEET 8 OF 9	

SOLDERING

SMT REFLOW SOLDERING INSTRUCTIONS



SOLDERING INSTRUCTIONS

TYPES	DIP AND WAVE SOLDERING			IRON SOLDERING(WITH 1.5mm IRON TIP)		
	TEMPERATURE OF THE SOLDERING BATH	MAXIMUM SOLDERING TIME	DISTANCE FROM SOLDER JOINT TO CASE	TEMPERATURE OF SOLDERING IRON	MAXIMUM SOLDERING TIME	DISTANCE FROM SOLDER JOINT TO CASE
LEDS	$\leq 260^{\circ}\text{C}$	3S	$> 2\text{mm}$	$\leq 260^{\circ}\text{C}$	3S	$> 2\text{mm}$
	$\leq 260^{\circ}\text{C}$	5S	$> 4\text{mm}$	$\leq 260^{\circ}\text{C}$	5S	$> 4\text{mm}$
DISPLAYS	$\leq 260^{\circ}\text{C}$	3S	$> 2\text{mm}$	$\leq 260^{\circ}\text{C}$	3S	$> 2\text{mm}$
DISPLAYS	$\leq 260^{\circ}\text{C}$	3S	$> 2\text{mm}$	$\leq 260^{\circ}\text{C}$	3S	$> 2\text{mm}$

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SMD HANDLING AND APPLICATION PRECAUTIONS

STORAGE

(1.1) It is recommended to store the devices in accordance with the following conditions:

Humidity: 60%RH Max.

Temperature: 5°C~30°C (41°F~86°F)

(1.2) Shelf life in sealed bag: 12 month at <5°C~30°C and <30%RH.

After the package is opened, the products should be used within 72hrs.

Or they should be kept at $\leq 20\%RH$ in zip -locked sealed bags.

DRY PACK AND BAKING

SMD LEDs are MOISTURE SENSITIVE devices. Avoid absorbing moisture at any time during transportation and/or storage. It is recommended to bake before soldering when the pack is unsealed after 72 hrs, or any suspicious moisture being found. Bake devices in accordance with the following conditions:

(a) 60 \pm 3°C x (12~24hrs) and <5%RH, taped reel type

(b) 100 \pm 3°C x (45min~1hr), loose packing type, or

(c) 130 \pm 3°C x (15~30min), loose packing type

ELECTRIC STATIC DISCHARGE(ESD) PROTECTION

Materials with GaN, InGaN, AlInGaP are STATIC SENSITIVE devices. They will be packed in anti-static bags. ESD protection must be deliberately observed from the initial design stage. The static -electric discharge may result in severe malfunction of the devices. In the events of manual working in process, make sure the devices are well protected from ESD at any time. Surge before and during handling products.